

Holding device having an oscillatory ultramicrotome
cutter

Technical Field

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The invention relates to a holding device having an oscillatory ultramicrotome cutter in accordance with the preamble of patent claim 1.

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Prior Art

It is proposed in EP-A-0'924'503 to set an ultramicrotome cutter oscillating parallel to its edge, in order to obtain ultrathin sample pieces in a range
15 from 10 to 200 nm and cut in an undistorted fashion. The cutter is fastened on a cutter holder that is connected to a base via a resilient element. Arranged on a second holder likewise connected to the base is a piezoelectric element that exerts a force on the cutter
20 holder in order to set the cutter blade oscillating.

Although good results are obtained in some cases with the aid of ultramicrotome cutters driven in such a way, samples of inadequate cutting quality also keep
25 occurring nevertheless. This is the case, in particular, in cryo-ultramicrotomy, where deep-frozen samples are cut in a temperature range of down to -160°C.

30 DE-C-38'20'085 discloses an ultramicrotome that has on a base a cutter holder with a cutting edge. The cutter itself is held via bearings, it being possible to move these bearings with the aid of a piezoelectric element.

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Summary of the Invention

It is therefore an object of the invention to improve the holding device for an ultramicrotome cutter of the

type mentioned at the beginning.

This object is achieved by a holding device having the features of patent claim 1.

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In the holding device according to the invention, the cutter is supported by a piezoelectric element that sets the cutter oscillating. The cutter is preferably otherwise freely suspended. It is therefore supported
10 exclusively by the piezoelectric element.

As a result, the piezoelectric element need move only a relatively slight mass. It is therefore possible to achieve relatively high frequencies, and the movement
15 can be executed in a more targeted fashion. Drifting can be reduced to a minimum.

Ultrathin sections or sample pieces can be obtained. The sections obtained are regular, and the sample piece
20 cut is not compressed but maintains its original shape. The holding device according to the invention is suitable, even though not exclusively, for use in cryo-ultramicrotomy.

25 A further advantage is that the holding device according to the invention has a very simple design. It can therefore be produced with the highest accuracy and yet in a relatively cost-effective fashion.

30 It is preferred to make use of so-called shear piezoelectric crystals or piezoelectric ceramics that expand or contract in a direction perpendicular to the applied voltage, that is to say execute a shearing movement. An oscillating movement parallel to the
35 cutter edge can be achieved in a simple way by means of these piezoelectric elements.

Further advantageous embodiments are laid down in the dependent patent claims.

Brief Description of the Drawings

The subject matter of the invention is explained below
5 with the aid of preferred exemplary embodiments that
are illustrated in the attached drawings, in which:
figure 1a shows a perspective view of a holding device
according to the invention from the front, in
a first embodiment;
10 figure 1b shows a partial section through the holding
device in accordance with figure 1a;
figure 2a shows a perspective view of the holding
device in accordance with figure 1a and of a
sample holding device;
15 figure 2b shows an exploded view of figure 2a;
figure 3 shows a partial section through a holding
device according to the invention, in
accordance with a second embodiment; and
figure 4 shows a perspective view of a holding device
20 according to the invention, in accordance
with a third embodiment.

Ways of Implementing the Invention

25 Figures 1a and 1b show a holding device according to
the present invention in accordance with a first
preferred embodiment. The holding device has a cutter
holder 1, a cutter 2 and a first piezoelectric element
3.

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The cutter holder 1 is preferably produced from a metal
or from a plastic and preferably has a cuboidal basic
shape. It has on one end face a groove 10 that is
bounded by side walls 11 and a groove base 12. The side
35 walls 11 preferably run parallel to one another, and
preferably form an at least approximately right angle
with the groove base 12. The groove base 12 is designed
as an oblique surface, i.e. it runs inclined to the

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side walls 11. The cutter holder 1 can have a depression 13 behind the groove 10 at one end of the groove base 12. If the cutter is used in classical ultramicrotomy, this depression 13 serves for holding water. Cut sample pieces float on this water. The depression is superfluous if the cutter is used in cryo-ultramicrotomy. The cut sample pieces slide in this case on the cutter surface, from which they are lifted off.

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The piezoelectric element 3 is fastened on the groove base 12. It is preferably bonded fast thereon. Suitable for this purpose are all known adhesives that promote a sufficiently strong connection. Particularly in the case of low temperature applications, the adhesive must be resistant even for high temperature differences, which can certainly amount to up to 180°C, specifically from -160°C up to room temperature.

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The piezoelectric element 3 is preferably designed as a flat cuboid with plane-parallel first and second supporting surfaces 30, 31. It is bonded to the cutter holder 1 with the first supporting surface 30, while the cutter 2 is bonded on the second supporting surface 31 and is thereby supported by the piezoelectric element 3 and is otherwise freely suspended. Other types of fastening can be used on both sides. The piezoelectric element 3 is a shear piezoelectric element here. Given an applied electric field, it therefore executes a shear movement perpendicular to the field lines. The shear piezoelectric element can be of single-layer or multilayer type. Metal layers at which contact wires are fitted are pre-deposited on both lateral surfaces, which here form the supporting surfaces 30, 31.

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In the cutter holder 1, movement of the piezoelectric element is at least approximately, preferably

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precisely, parallel to the groove base 12. For this purpose, the groove 12 has a width that is greater than the width of the piezoelectric element 3 and than the width of a blade holder 22, described below, of the cutter 2. Typical oscillation frequencies lie between 30 kHz and 200 kHz. High frequencies have the advantage that the drift is relatively low, and that the quality of the cut sample pieces, that is to say the cuts, is high.

The cutter 2 has a preferably cuboidal blade holder 22, and a blade 20 arranged thereon and with a cutting edge 21. The cutting edge 21 runs at least approximately parallel to the second bearing surface 31 of the piezoelectric element 3, thus also to the groove base 12. If an AC voltage is applied to the piezoelectric element 3, the cutter oscillates in a fashion at least approximately parallel, preferably precisely parallel, to the direction in which its cutting edge 21 extends. This is illustrated by an arrow in the figure.

The blade holder 22 and the blade 20 can be of unipartite design (made in one piece). However, it is also possible for them to be of multipartite design so that the blade 20 can be exchanged per se. If they are of unipartite design, the entire holding device is preferably exchanged. At least the blade 20 preferably consists of diamond.

The holding device is illustrated in figures 2a and 2b in a fashion operationally connected to a sample 7 to be cut. The sample 7 can be any desired material for which the aim is to cut off an ultrathin slice for the purpose of analysis under a suitable microscope. As mentioned at the beginning, it is possible to achieve at least cut thicknesses of between 10 to 100 nm, the quality of the ultrathin cuts being improved with the

aid of the holding device according to the invention. The sample is usually a tissue or some other organic material. However, it is also possible for inorganic materials to be cut in this way.

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The sample 7 is held in a sample holder 6 that is fastened on a sample holder block 4. The sample holder block 4 and the cutter holder 1 can, but need not, be arranged on the same base (not illustrated here) of the ultramicrotome. In one variant of the method, during cutting the sample 7 remains at rest and only the cutter oscillates. In another variant, the sample 7 also oscillates. It is possible for this purpose to arrange between the sample holder 6 and sample holder block 4 a second piezoelectric element 5, preferably also a shear piezoelectric element. Consequently, the sample 7 can likewise move in a simple way in a direction at least approximately parallel to the edge 21. The sample 7 then preferably moves in the opposite direction to the cutter 2. It is also possible to set the sample 7 oscillating with a time offset in the same direction or the opposite one such that the sample 7 moves at the reversal point of the cutter 2, and the cutter 2 moves at the reversal point of the sample 7.

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A second preferred exemplary embodiment of the holding device according to the invention is illustrated in figure 3. This holding device differs from the first exemplary embodiment in that the piezoelectric element 3 is now no longer arranged in the shape of a flat cuboid between the groove base 12 and cutter 2. Rather, the piezoelectric element 3 is now arranged at an end of the blade holder 22 that is on its opposite end viewed from the blade 20. This embodiment has the advantage that the cutter 2 can itself be of very short design such that the mass to be moved is minimized. Since the cutter can be fastened in advance on the piezoelectric element, and it is only at the end that

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the unit formed by the cutter and piezoelectric element need be fastened on the cutter holder, the production is additionally facilitated and the measuring accuracy is increased. Also quality assurance is improved, since
5 the cutter/piezoelectric element unit can be tested by itself before installation in the cutter holder 1.

In an embodiment not illustrated here, the piezoelectric crystal or piezoelectric ceramic is
10 bonded directly to the groove base 12. However, the piezoelectric element 3 preferably has not only a piezoelectric crystal or a piezoelectric ceramic 32 but also a piezo holder 33, as illustrated here. This piezo holder 33 is of cuboidal design and is bonded with a
15 preferably wide supporting surface to the groove base 12. This has the advantage that it is possible to use a relatively small piezoelectric crystal or a small piezoelectric ceramic 32 but that a sufficiently large area serves nevertheless as a bonding area. The cutter
20 2 oscillates freely with reference to the groove base 12. The groove base 12 can therefore have a corresponding step (not illustrated here).

In the examples described above, the cutter holder 1
25 has the groove 10. This groove 10 has the advantage that it serves as a guide aid when fastening the piezoelectric element and the cutter. However, the groove 10 is not mandatory. The cutter holder 1 can also basically have another shape. All that is
30 essential is that the piezoelectric element needs to move only the cutter and no further elements, or as few further elements as possible.

A third embodiment is illustrated in figure 4. Here,
35 the holding device according to the invention has a cutter holder block 8 on which the piezoelectric element 3 is fastened. It may in turn be bonded, but here it is screwed. The cutter holder 1 with the cutter

2 fastened, in particular bonded, therein in a fixed position is arranged freely suspended on the piezoelectric element 3. By applying an AC voltage to the piezoelectric element 3, it is possible, in turn, to set the cutter blade 20 oscillating parallel to its longitudinal direction, as illustrated by an arrow. In this embodiment, it is also possible to use as the piezoelectric element a crystal or a ceramic that expands in a direction parallel to the applied electric field. It is preferred to use a multilayer element. It is an advantageous feature of the embodiment illustrated that the cutter holder forms a screw head, the associated screw body penetrating the piezoelectric element and being held on the opposite side by a lock nut 9 braced against the cutter holder block 8. This arrangement has the advantage that the required pressure build-up in the piezoelectric element is achieved, and the cutter can be held, with one and the same element.

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The holding device according to the invention can be produced simply and with high dimensional accuracy. It also permits the cutter edge to oscillate at a high frequency.

List of reference numerals

	1	Cutter holder
	10	Groove
5	11	Side walls
	12	Groove base
	13	Depression
	2	Cutter
	20	Blade
10	21	Cutting edge
	22	Blade holder
	3	First piezoelectric element
	30	First supporting surface
	31	Second supporting surface
15	32	Piezoelectric crystal
	33	Piezoelectric holder
	4	Sample holder block
	5	Second piezoelectric element
	6	Sample holder
20	7	Sample
	8	Cutter holder block
	9	Lock nut